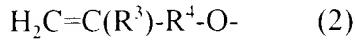


(a) a polyether oligomer the main chain of which comprises a polyether and which contains at least one unsaturated group represented by

the general formula (2) or the general formula (3):



wherein R^3 represents a hydrocarbon group containing up to 10 carbon atoms and R^4 represents a divalent organic group containing 1 to 20 carbon atoms and at least one member selected from the group consisting of hydrogen, oxygen and nitrogen as a constituent atom,

per molecule, with

(b) a reactive silicon group-containing compound in the presence of

(c) a group VIII transition metal catalyst.

3. (Amended) The curable resin composition according to Claim 1 or 2

wherein the reactive silicon group-containing polyether oligomer (I) is derived from a polyether oligomer obtained by ring-opening addition polymerization of an alkylene oxide in the presence of a double metal cyanide complex catalyst.

6. (Amended) The curable resin composition according to Claim 1 wherein the group VIII transition metal catalyst (c) is at least one member selected from the group consisting of platinum-vinylsiloxane complexes and platinum-olefin complexes.

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7. (Twice Amended) The curable resin composition according to Claim 1 wherein R³ in the general formula (2) or (3) represents -CH₃ or -CH₂CH₃.

Please add new claims 12 and 13 as follows:

12. (Newly added) The curable resin composition according to Claim 1, wherein the introduction ratio is not less than 90%.

13. (Newly added) The curable resin composition according to Claim 1, wherein the introduction ratio is not less than 97%.